

EC3SMB-3.579545M TR



ITEM DESCRIPTION

Quartz Crystal Resonator HC49/UP 4 Pad Surface Mount (SMD) 4.0mm Height Metal Resistance Weld Seal 3.579545MHz ± 50 ppm at 25°C, ± 100 ppm over -40°C to +85°C 18pF Parallel Resonant

ELECTRICAL SPECIFICATIONS

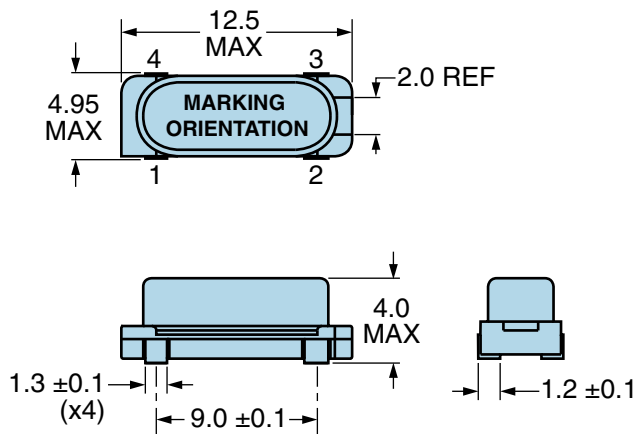
Nominal Frequency	3.579545MHz
Frequency Tolerance/Stability	± 50 ppm at 25°C, ± 100 ppm over -40°C to +85°C
Aging at 25°C	± 5 ppm/year Maximum
Load Capacitance	18pF Parallel Resonant
Shunt Capacitance (C0)	7pF Maximum
Equivalent Series Resistance	200 Ohms Maximum
Mode of Operation	AT-Cut Fundamental
Drive Level	1mWatts Maximum
Storage Temperature Range	-40°C to +85°C
Insulation Resistance	500 Megaohms Minimum at 100Vdc

ENVIRONMENTAL & MECHANICAL SPECIFICATIONS

Fine Leak Test	MIL-STD-883, Method 1014 Condition A
Gross Leak Test	MIL-STD-883, Method 1014 Condition C
Mechanical Shock	MIL-STD-202, Method 213 Condition C
Resistance to Soldering Heat	MIL-STD-202, Method 210
Resistance to Solvents	MIL-STD-202, Method 215
Solderability	MIL-STD-883, Method 2003
Temperature Cycling	MIL-STD-883, Method 1010
Vibration	MIL-STD-883, Method 2007 Condition A

EC3SMB-3.579545M TR

MECHANICAL DIMENSIONS (all dimensions in millimeters)

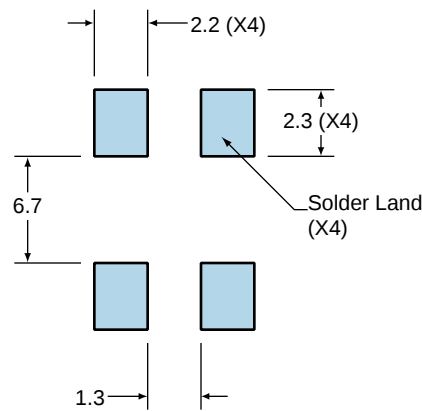


PIN	CONNECTION
1	Crystal
2	Connected to Pin 3
3	Connected to Pin 2
4	Crystal

LINE	MARKING
1	E3.5795 <i>E=Ecliptek Designator</i>

Suggested Solder Pad Layout

All Dimensions in Millimeters



All Tolerances are ±0.1

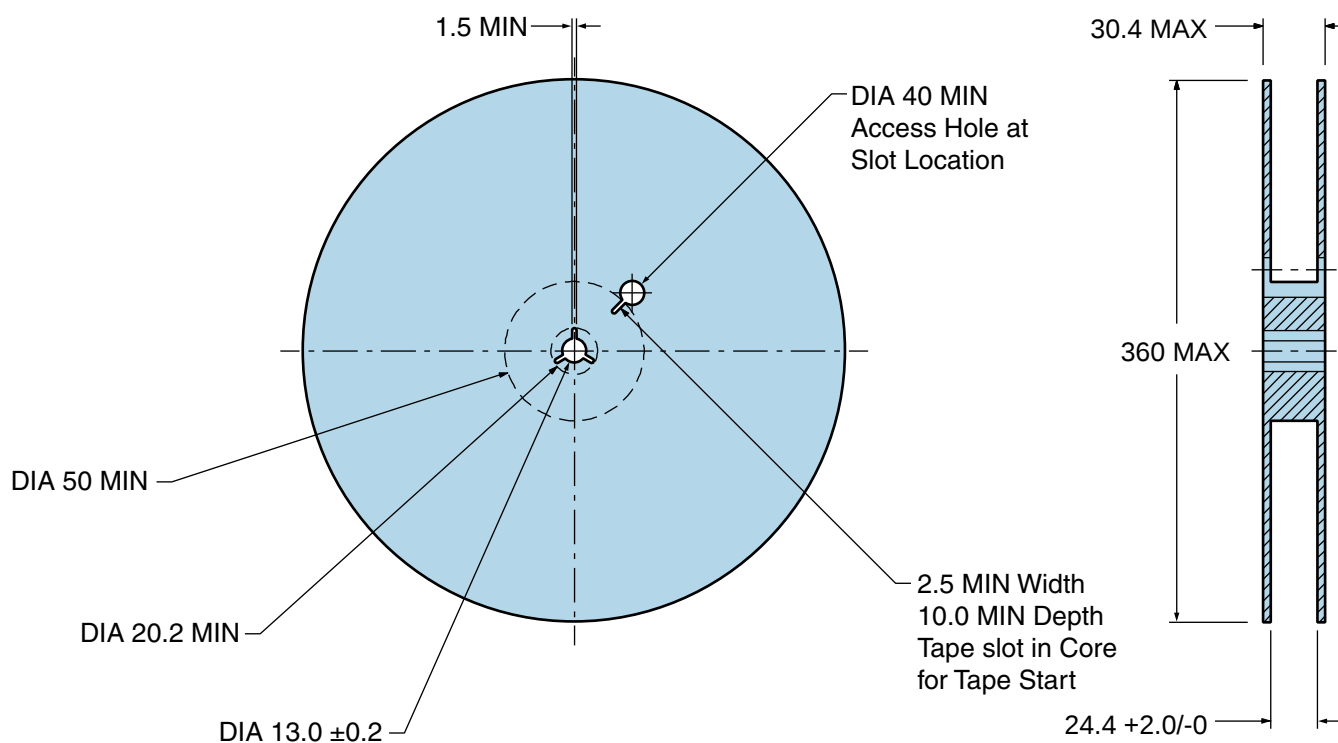
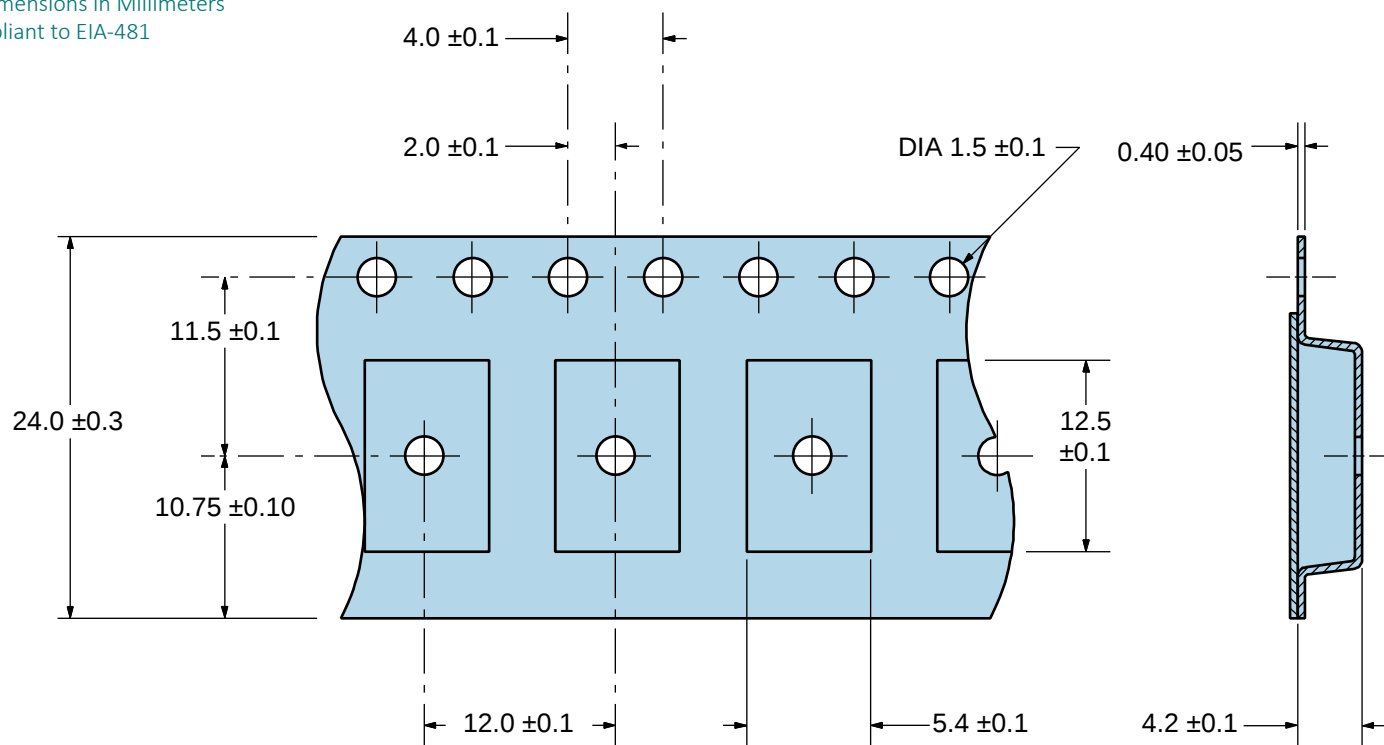
EC3SMB-3.579545M TR

Tape & Reel Dimensions

Quantity Per Reel: 1,000 units

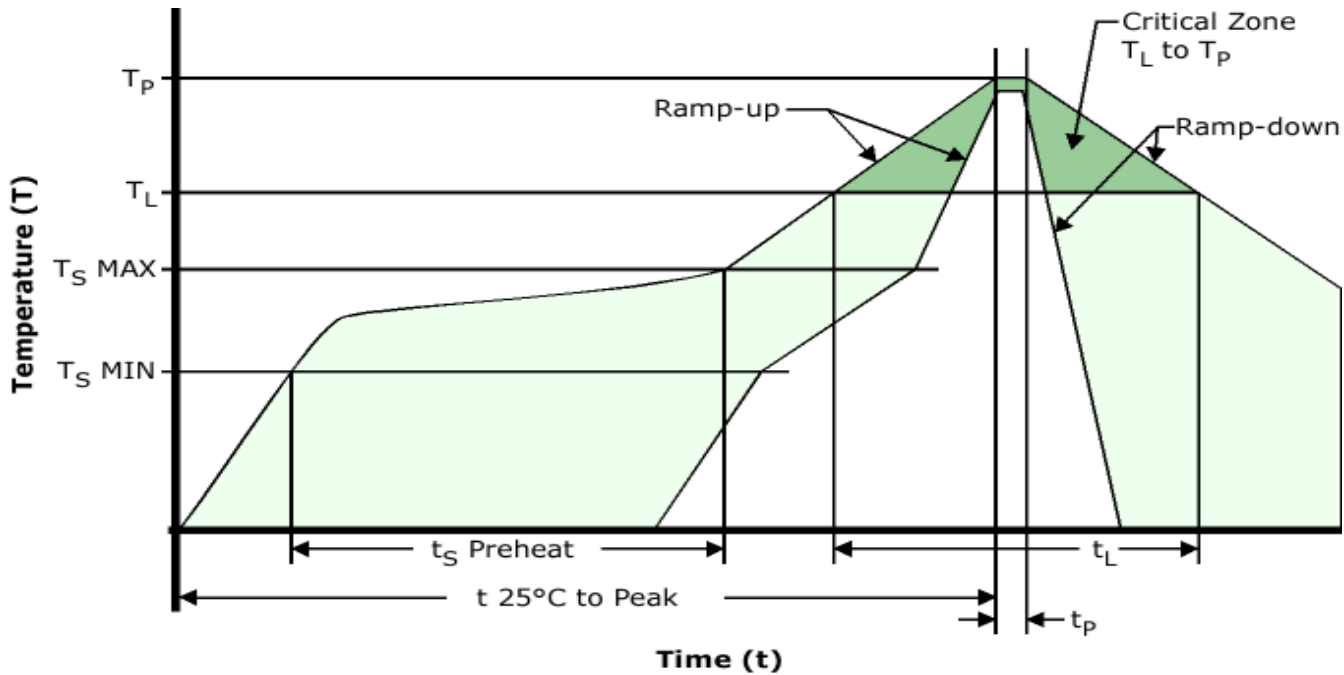
All Dimensions in Millimeters

Compliant to EIA-481



EC3SMB-3.579545M TR

Recommended Solder Reflow Methods



Low Temperature Infrared/Convection 225°C

TS MAX to TL (Ramp-up Rate)	5°C/Second Maximum
-----------------------------	--------------------

Preheat

- Temperature Minimum (TS MIN)	N/A
- Temperature Typical (TS TYP)	150°C
- Temperature Maximum (TS MAX)	N/A
- Time (ts MIN)	30 - 60 Seconds

Ramp-up Rate (TL to TP)	5°C/Second Maximum
-------------------------	--------------------

Time Maintained Above:

- Temperature (TL)	150°C
- Time (tL)	200 Seconds Maximum

Peak Temperature (TP)	225°C Maximum
-----------------------	---------------

Target Peak Temperature (TP Target)	225°C Maximum 2 Times
-------------------------------------	-----------------------

Time within 5°C of actual peak (tp)	80 Seconds Maximum 2 Times
-------------------------------------	----------------------------

Ramp-down Rate	5°C/Second Maximum
----------------	--------------------

Time 25°C to Peak Temperature (t)	N/A
-----------------------------------	-----

Moisture Sensitivity Level	Level 1
----------------------------	---------

Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum.

High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum.